

FOR IMMEDIATE RELEASE



Ronkonkoma, Long Island, New York (April 15, 2013)
GM Systems represented Cirtek, Silicon Link, Sysacom, Micro Printing Systems, Sentec, PNL INNOTECH, Kerdry, Microcertec, Micro-Coat, Koartan Microelectronic Interconnect Materials, Crafronics, AyDeeKay, Agile Microwave Technology, and Advanced Circuit Technology.

Take a look at some of the highlights of the microelectronic trade show hosted by the Metro Chapter of IMAPS (International Microelectronic and Packaging Society) at the Full Day Symposium and Vendor Night Thursday, April 11, 2013. (Holiday Inn Ronkonkoma, 3845 Veterans Highway, Ronkonkoma, N.Y. 11779).

The conference presented a seminar on “Introduction to the Basics of Conventional and Advanced Microelectronic Packaging ” given by Tom Terlizzi, GM Systems, with Norman Chang, Cirtek presenting Cirtek’s molded semiconductor and RF packaging line.

Two interesting papers where presented on electronic packaging:

“Advanced High Frequency Microelectronics” by Harvey Smith (EMA)
Sandvik Osprey CE Alloys

“DNA Marking: Implementation of a Proactive Counterfeit Risk Mitigation Solution” by Janice Meraglia, Applied DNA Sciences

A Mini Trade show with over 45 suppliers and sales representatives of microelectronic, SMT components, manufacturing and test equipment and assembly services with over 120 attendees.

Some of the companies exhibiting were:

Micross, Newport, Eastern States, Avid Associates, Proton Onsite, AdTech Ceramics, PEI, HMI, WJB Sales, Inc., GM Systems, Cirtek, Silicon Link, Sysacom, Micro Printing Systems, Sentec, PNL INNOTECH, Kerdry, Microcertec, Micro-Coat, Koartan Microelectronic Interconnect Materials, Crafronics, AyDeeKay Agile Microwave Technology, Advanced Circuit Technology, Static Solutions, AI Technology LFG Micro, Epoxy Technology, Gel Pack/Quick Pak, EMA Sales &

Marketing, Finetech, Henkel, Century Seals, O & S Sales, UTZ, Palomar, Interfet Corporation, Century Seals, HMI .



On the left photograph is Norman Chang, Cirtek and Tom Terlizzi, GM Systems on the right.

The left photograph is a closer view of the Cirtek/Silicon Link poster board presentation.